

TSMC00-079



COPY OF PAPERS
ORIGINALLY FILED

HF 11700

#7/B

May 13 2002

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

ATTN: GROUP ART UNIT 1765 L. VINH

FR: Stephen B. Ackerman Reg. No. 37761
20 McIntosh Drive
Poughkeepsie, N.Y. 12603

RECEIVED
JUN 12 2002
TC 1700

Subject:

Serial No. 09/579,542	05/26/00
Cheng Chung Lin and Lain-Jong Li	
"Method to improve stability and reliability of CVD low k dielectric"	
Grp. Art Unit :1765	L. Vinh

RESPONSE TO FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated March 21 2002, in the above identified application for patent, please enter the following amendments and consider the following remarks.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on May 29, 2002.

Name Stephen B. Ackerman, Reg #37,761
Signature/Date [Signature] 5/29/02